

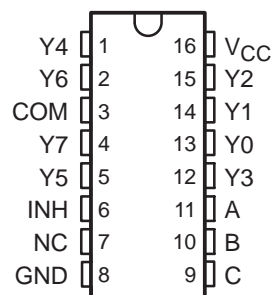
# SN74HC4851

## 8-CHANNEL ANALOG MULTIPLEXER/DEMUTIPLEXER WITH INJECTION-CURRENT EFFECT CONTROL

SCLS542B – SEPTEMBER 2003 – REVISED JANUARY 2004

- Injection-Current Cross Coupling <1mV/mA (see Figure 1)
- Low Crosstalk Between Switches
- Pin Compatible With SN74HC4051, SN74LV4051A, and CD4051B
- 2-V to 6-V  $V_{CC}$  Operation
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)

D, DGV, N, OR PW PACKAGE  
(TOP VIEW)



NC – No internal connection

### description/ordering information

This eight-channel CMOS analog multiplexer/demultiplexer is pin compatible with the '4051 function and, additionally, features injection-current effect control, which has excellent value in automotive applications where voltages in excess of normal supply voltages are common.

The injection-current effect control allows signals at disabled analog input channels to exceed the supply voltage without affecting the signal of the enabled analog channel. This eliminates the need for external diode/resistor networks typically used to keep the analog channel signals within the supply-voltage range.

### ORDERING INFORMATION

$T_A$	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
–40°C to 125°C	PDIP – N	Tube	SN74HC4851N	HC4851N
		Tube	SN74HC4851D	HC4851
	SOIC – D	Tape and reel	SN74HC4851DR	
		Tube	SN74HC4851PW	HC4851
	TSSOP – PW	Tape and reel	SN74HC4851PWR	
		Tape and reel	SN74HC4851DGVR	HC4851

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS  
INSTRUMENTS**

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# SN74HC4851

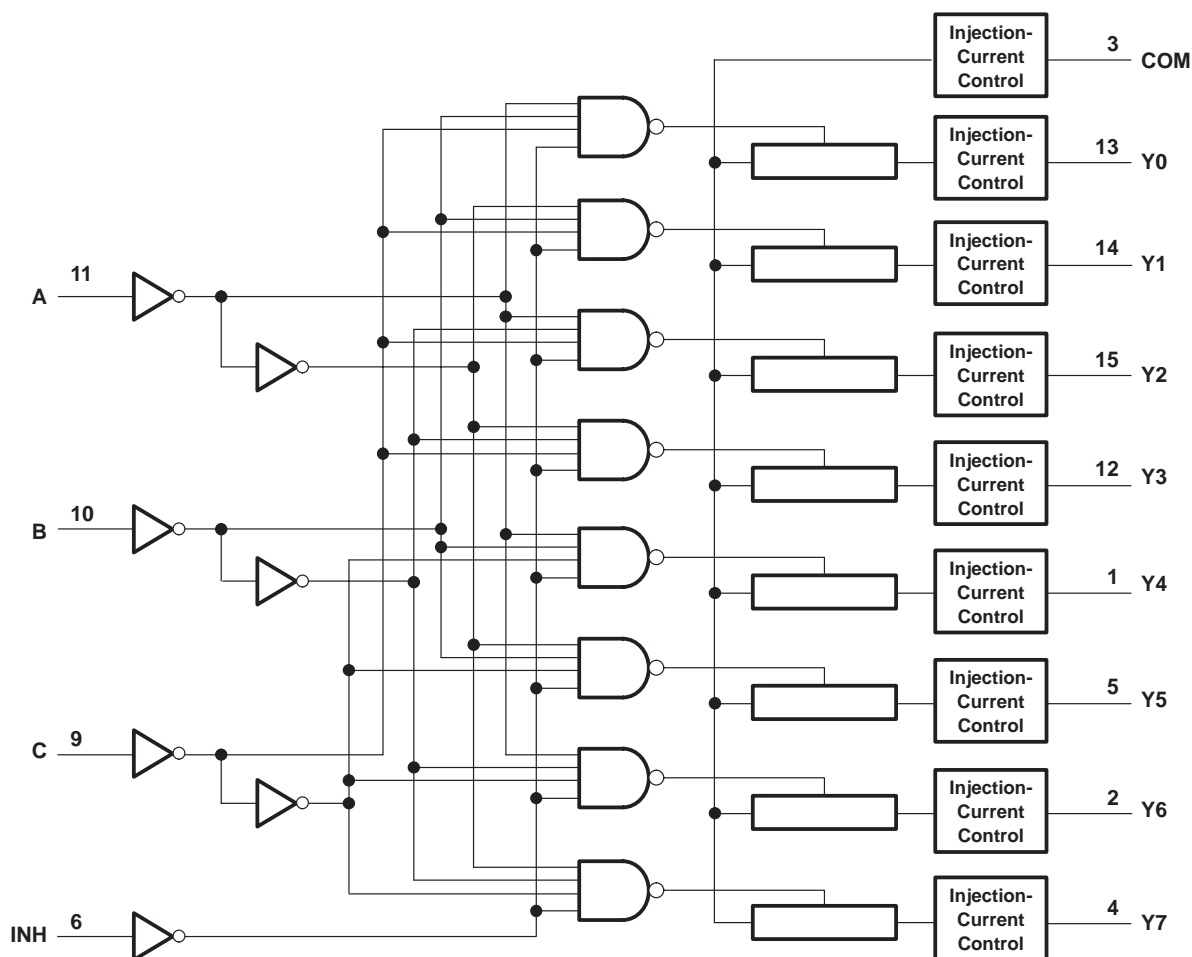
## 8-CHANNEL ANALOG MULTIPLEXER/DEMULTIPLEXER WITH INJECTION-CURRENT EFFECT CONTROL

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FUNCTION TABLE

INPUTS				ON CHANNEL
INH	C	B	A	
L	L	L	L	Y0
L	L	L	H	Y1
L	L	H	L	Y2
L	L	H	H	Y3
L	H	L	L	Y4
L	H	L	H	Y5
L	H	H	L	Y6
L	H	H	H	Y7
H	X	X	X	None

logic diagram (positive logic)



## 3

**SN74HC4851**
**8-CHANNEL ANALOG MULTIPLEXER/DEMULTIPLEXER  
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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	V <sub>CC</sub>	T <sub>A</sub> = 25°C			UP TO 85°C		UP TO 125°C		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
r <sub>on</sub>	On-state switch resistance	I <sub>T</sub> ≤ 2 mA, V <sub>I</sub> = V <sub>CC</sub> to GND, V <sub>INH</sub> = V <sub>IL</sub> (see Figure 5)	2. V		500	650		670		700	Ω
			3 V		215	280		320		360	
			3.3 V		210	270		305		345	
			4.5 V		160	210		240		270	
			6 V		150	195		220		250	
Δr <sub>on</sub>	Difference in on-state resistance between switches	I <sub>T</sub> ≤ 2 mA, V <sub>I</sub> = V <sub>CC</sub> /2, V <sub>INH</sub> = V <sub>IL</sub>	2. V		4	10		15		20	Ω
			3 V		2	8		12		16	
			3.3 V		2	8		12		16	
			4.5 V		2	8		12		16	
			6 V		3	9		13		18	
I <sub>I</sub>	Control input current	V <sub>I</sub> = V <sub>CC</sub> or GND	6 V			±0.1		±0.1		±1	μA
I <sub>S(off)</sub>	Off-state switch leakage current (any one channel)	V <sub>I</sub> = V <sub>CC</sub> or GND, V <sub>INH</sub> = V <sub>IH</sub> (see Figure 6)	6 V			±0.1		±0.5		±1	μA
	Off-state switch leakage current (common channel)	V <sub>I</sub> = V <sub>CC</sub> or GND, V <sub>INH</sub> = V <sub>IH</sub> (see Figure 7)				±0.2		±2		±4	
I <sub>S(on)</sub>	On-state switch leakage current	V <sub>I</sub> = V <sub>CC</sub> or GND, V <sub>INH</sub> = V <sub>IL</sub> (see Figure 8)	6 V			±0.1		±0.5		±1	μA
I <sub>CC</sub>	Supply current	V <sub>I</sub> = V <sub>CC</sub> or GND	6 V			2		20		40	μA
C <sub>IC</sub>	Control input capacitance	A, B, C, INH			3.5	10		10		10	pF
C <sub>IS</sub>	Common terminal capacitance	Switch off			22	40		40		40	pF
C <sub>OS</sub>	Switch terminal capacitance	Switch off			6.7	15		15		15	pF

injection current coupling specifications, T<sub>A</sub> = –40°C to 125°C

PARAMETER		V <sub>CC</sub>	TEST CONDITIONS		MIN	TYP†	MAX	UNIT
V <sub>Δout</sub>	Maximum shift of output voltage of enabled analog channel	3.3 V	R <sub>S</sub> ≤ 3.9 kΩ	I <sub>I</sub> ‡ ≤ 1 mA		0.05	1	mV
		5 V				0.1	1	
		3.3 V		I <sub>I</sub> ‡ ≤ 10 mA		0.345	5	
		5 V				0.067	5	
		3.3 V	R <sub>S</sub> ≤ 20 kΩ	I <sub>I</sub> ‡ ≤ 1 mA		0.05	2	
		5 V				0.11	2	
		3.3 V		I <sub>I</sub> ‡ ≤ 10 mA		0.05	20	
		5 V				0.024	20	

† Typical values are measured at T<sub>A</sub> = 25°C.

‡ I<sub>I</sub> = total current injected into all disabled channels



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**switching characteristics over recommended operating free-air temperature range,  
V<sub>CC</sub> = 2 V, C<sub>L</sub> = 50 pF (unless otherwise noted) (see Figures 9–14)**

PARAMETER		FROM (INPUT)	TO (OUTPUT)	T <sub>A</sub> = 25°C			UP TO 85°C		UP TO 125°C		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t <sub>PLH</sub>	Propagation delay time	COM or Y <sub>n</sub>	Y <sub>n</sub> or COM		19.5	25		29		32	ns
t <sub>PHL</sub>	Propagation delay time	Channel Select	COM or Y <sub>n</sub>		23	30		35		40	ns
t <sub>PZH</sub>	Enable delay time	INH	COM or Y <sub>n</sub>			95		105		115	ns
t <sub>PHZ</sub>	Disable delay time	INH	COM or Y <sub>n</sub>			95		105		115	ns
t <sub>PLZ</sub>	Disable delay time										

**switching characteristics over recommended operating free-air temperature range,  
V<sub>CC</sub> = 3 V, C<sub>L</sub> = 50 pF (unless otherwise noted) (see Figures 9–14)**

PARAMETER		FROM (INPUT)	TO (OUTPUT)	T <sub>A</sub> = 25°C			UP TO 85°C		UP TO 125°C		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t <sub>PLH</sub>	Propagation delay time	COM or Y <sub>n</sub>	Y <sub>n</sub> or COM		12	15.5		17.5		19.5	ns
t <sub>PHL</sub>	Propagation delay time	Channel Select	COM or Y <sub>n</sub>		13.5	17.5		20		23	ns
t <sub>PZH</sub>	Enable delay time	INH	COM or Y <sub>n</sub>			90		100		110	ns
t <sub>PHZ</sub>	Disable delay time	INH	COM or Y <sub>n</sub>			90		100		110	ns
t <sub>PLZ</sub>	Disable delay time										

**switching characteristics over recommended operating free-air temperature range,  
V<sub>CC</sub> = 3.3 V, C<sub>L</sub> = 50 pF (unless otherwise noted) (see Figures 9–14)**

PARAMETER		FROM (INPUT)	TO (OUTPUT)	T <sub>A</sub> = 25°C			UP TO 85°C		UP TO 125°C		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t <sub>PLH</sub>	Propagation delay time	COM or Y <sub>n</sub>	Y <sub>n</sub> or COM		11	14.5		16.5		18.5	ns
t <sub>PHL</sub>	Propagation delay time	Channel Select	COM or Y <sub>n</sub>		12.5	16.5		19		22	ns
t <sub>PZH</sub>	Enable delay time	INH	COM or Y <sub>n</sub>			85		95		105	ns
t <sub>PHZ</sub>	Disable delay time	INH	COM or Y <sub>n</sub>			85		95		105	ns
t <sub>PLZ</sub>	Disable delay time										

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switching characteristics over recommended operating free-air temperature range,  
 $V_{CC} = 4.5\text{ V}$ ,  $C_L = 50\text{ pF}$  (unless otherwise noted) (see Figures 9–14)

PARAMETER		FROM (INPUT)	TO (OUTPUT)	$T_A = 25^\circ\text{C}$			UP TO $85^\circ\text{C}$		UP TO $125^\circ\text{C}$		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
tPLH	Propagation delay time	COM or Yn	Yn or COM		8.6	11.5		12.5		13.5	ns
tPLH	Propagation delay time	Channel Select	COM or Yn		10	13		15		17	ns
tPZH	Enable delay time	INH	COM or Yn			80		90		100	ns
tPHZ	Disable delay time	INH	COM or Yn			80		90		100	ns

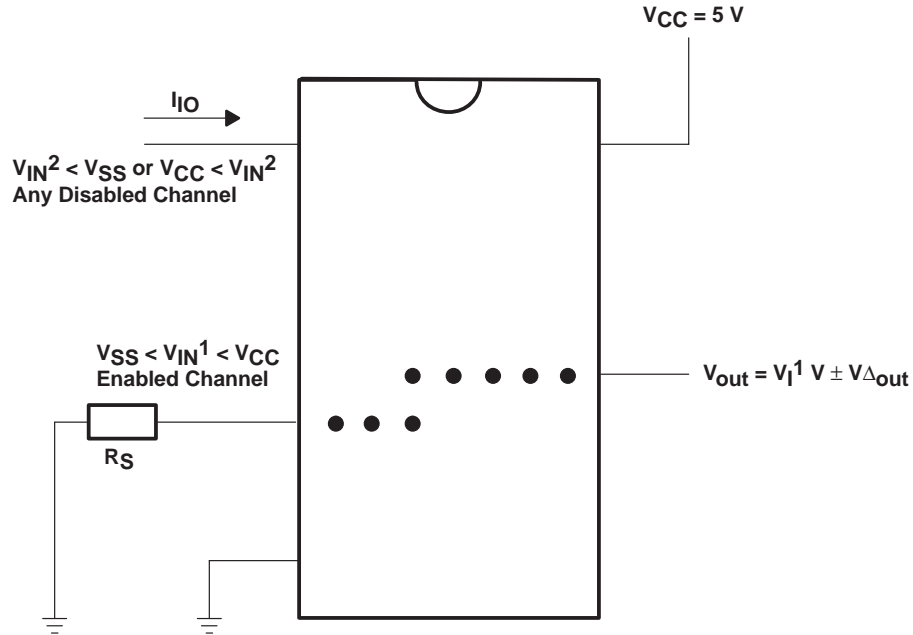
switching characteristics over recommended operating free-air temperature range,  
 $V_{CC} = 6\text{ V}$ ,  $C_L = 50\text{ pF}$  (unless otherwise noted) (see Figures 9–14)

PARAMETER		FROM (INPUT)	TO (OUTPUT)	$T_A = 25^\circ\text{C}$			UP TO $85^\circ\text{C}$		UP TO $125^\circ\text{C}$		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
tPLH	Propagation delay time	COM or Yn	Yn or COM		8	10		11		12	ns
tPLH	Propagation delay time	Channel Select	COM or Yn		9.5	12.5		14.5		16.5	ns
tPZH	Enable delay time	INH	COM or Yn			78		80		80	ns
tPHZ	Disable delay time	INH	COM or Yn			78		80		80	ns

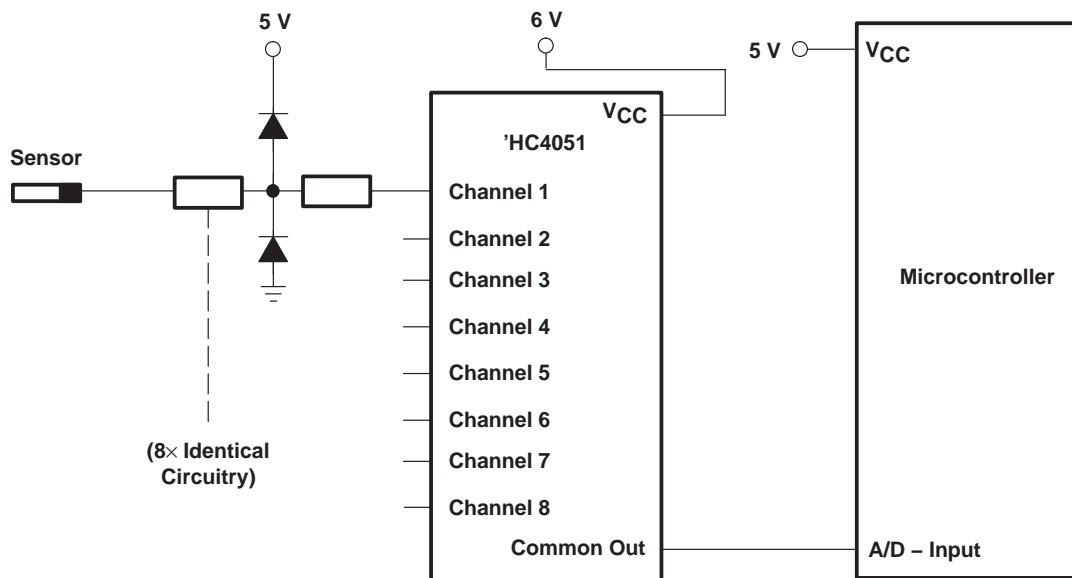
operating characteristics,  $T_A = 25^\circ\text{C}$  (see Figure 15)

PARAMETER		$V_{CC}$	TEST CONDITIONS	TYP	UNIT
C <sub>pd</sub>	Power dissipation capacitance	3.3 V	No load	32	pF
		5 V		37	

## APPLICATION INFORMATION



**Figure 1. Injection-Current Coupling Specification**



**Figure 2. Alternate Solution Requires 32 Passive Components and One Extra 6-V Regulator to Suppress Injection Current Into a Standard 'HC4051 Multiplexer**

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## 8-CHANNEL ANALOG MULTIPLEXER/DEMULTIPLEXER

### WITH INJECTION-CURRENT EFFECT CONTROL

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#### APPLICATION INFORMATION

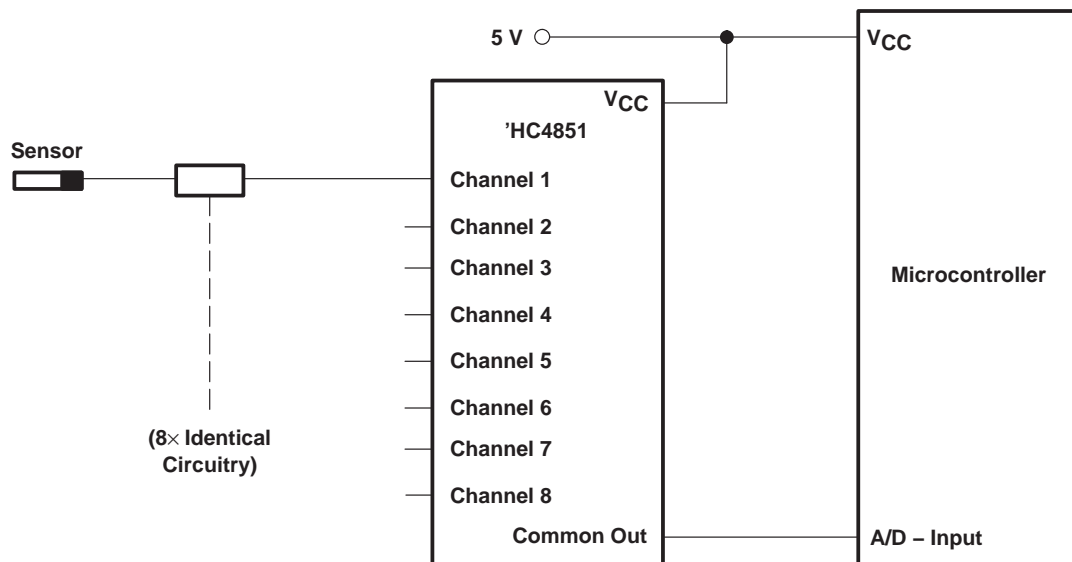


Figure 3. Solution by Applying the 'HC4851 Multiplexer

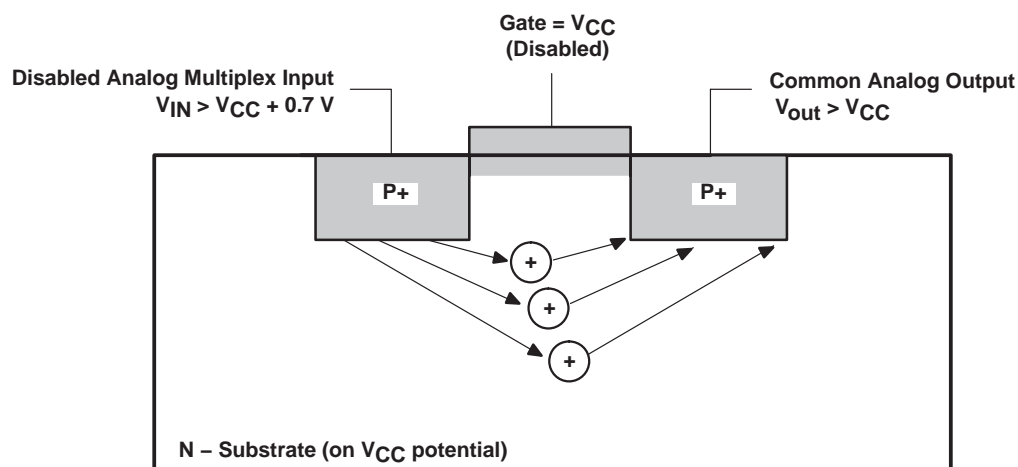


Figure 4. Diagram of Bipolar Coupling Mechanism  
(Appears if  $V_{IN}$  Exceeds  $V_{CC}$ , Driving Injection Current Into the Substrate)



## PARAMETER MEASUREMENT INFORMATION

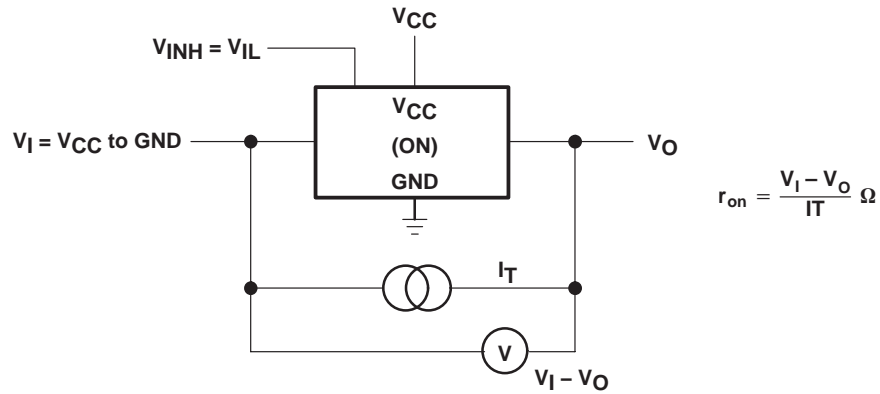


Figure 5. On-State-Resistance Test Circuit

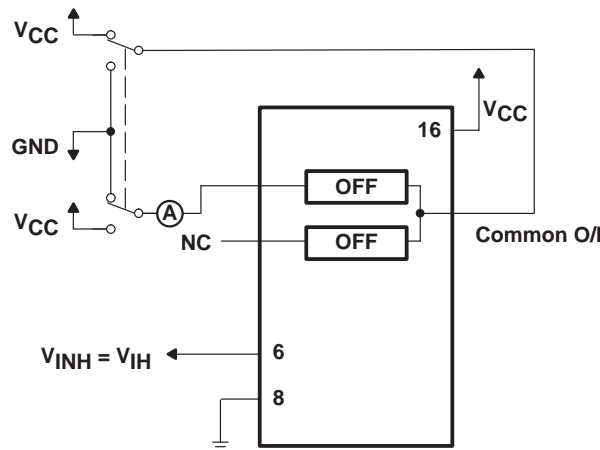


Figure 6. Maximum Off-Channel Leakage Current, Any One Channel, Test Setup

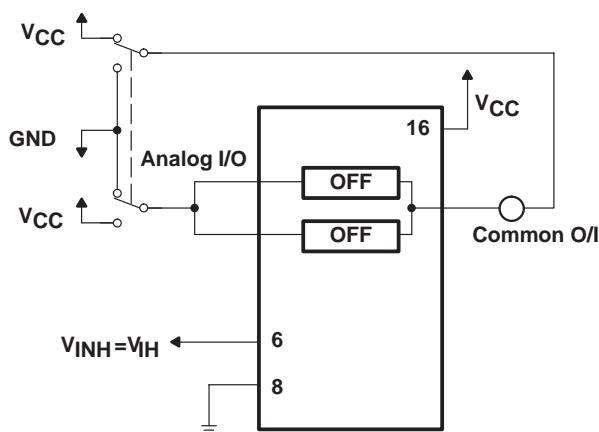


Figure 7. Maximum Off-Channel Leakage Current, Common Channel, Test Setup

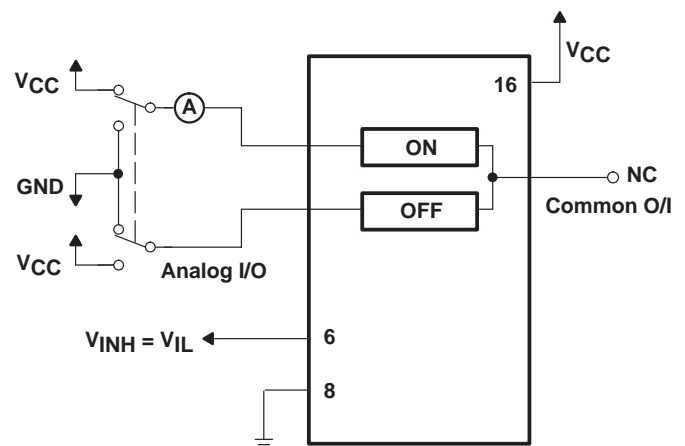


Figure 8. Maximum On-Channel Leakage Current, Channel To Channel, Test Setup

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## 8-CHANNEL ANALOG MULTIPLEXER/DEMULTIPLEXER WITH INJECTION-CURRENT EFFECT CONTROL

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### PARAMETER MEASUREMENT INFORMATION

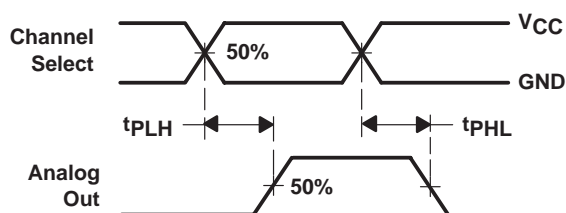


Figure 9. Propagation Delays,  
Channel Select to Analog Out

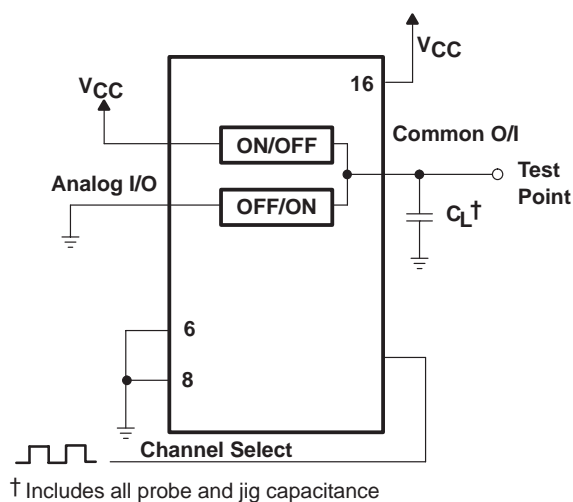


Figure 10. Propagation-Delay Test Setup,  
Channel Select to Analog Out

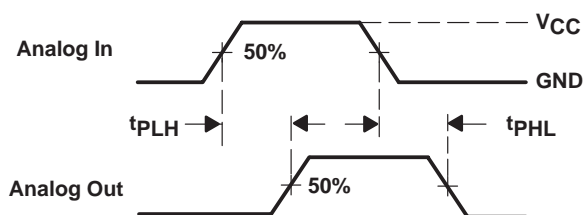


Figure 11. Propagation Delays,  
Analog In to Analog Out

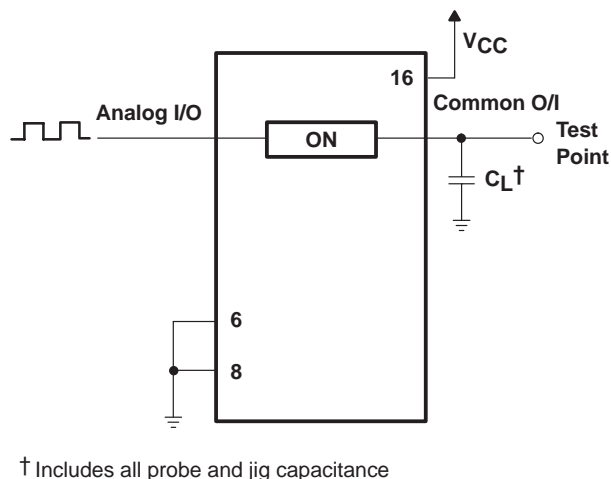
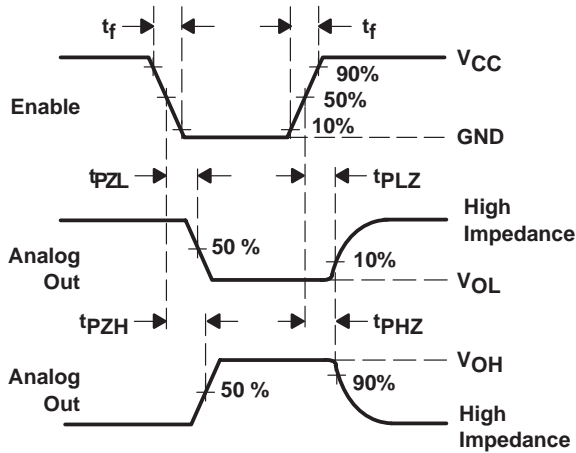
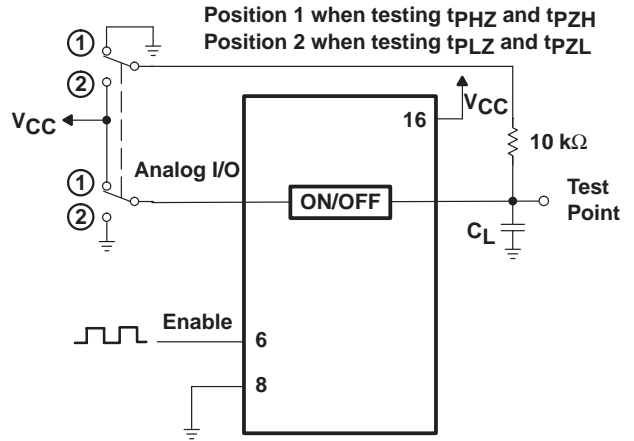


Figure 12. Propagation-Delay Test Setup,  
Analog In to Analog Out

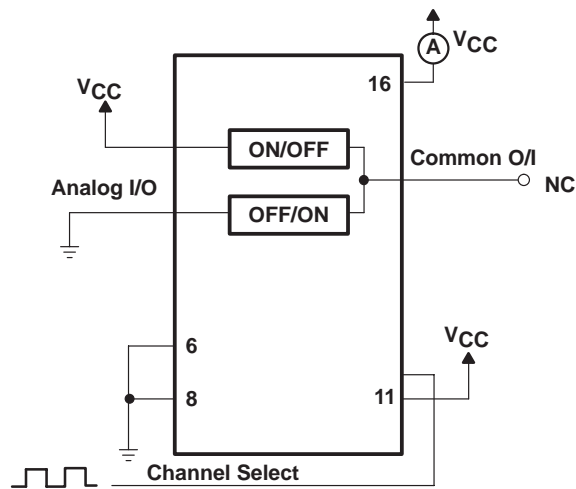
## PARAMETER MEASUREMENT INFORMATION



**Figure 13. Propagation Delays,  
Enable to Analog Out**



**Figure 14. Propagation-Delay Test Setup,  
Enable to Analog Out**



**Figure 15. Power-Dissipation Capacitance Test Setup**

**PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
SN74HC4851D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC4851DE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC4851DGVR	ACTIVE	TVSOP	DGV	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC4851DGVRE4	ACTIVE	TVSOP	DGV	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC4851DR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC4851DRE4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC4851N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74HC4851NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74HC4851PW	ACTIVE	TSSOP	PW	16	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC4851PWE4	ACTIVE	TSSOP	PW	16	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC4851PWR	ACTIVE	TSSOP	PW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC4851PWRE4	ACTIVE	TSSOP	PW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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## N (R-PDIP-T\*\*)

16 PINS SHOWN

## PLASTIC DUAL-IN-LINE PACKAGE



PINS **	14	16	18	20
DIM				
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS-001 VARIATION	AA	BB	AC	AD



4040049/E 12/2002

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
  - The 20 pin end lead shoulder width is a vendor option, either half or full width.

## DGV (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE

24 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.  
 D. Falls within JEDEC: 24/48 Pins – MO-153  
 14/16/20/56 Pins – MO-194

## D (R-PDSO-G16)

## PLASTIC SMALL-OUTLINE PACKAGE



## NOTES:

- All linear dimensions are in inches (millimeters).
- This drawing is subject to change without notice.
- Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- Falls within JEDEC MS-012 variation AC.



## PW (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-153

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